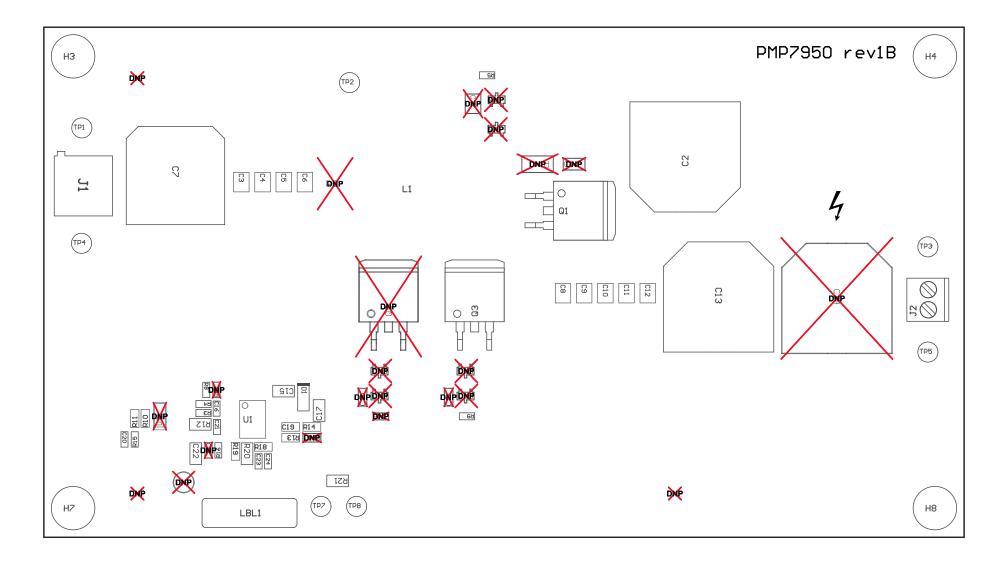
ZZ1 Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1

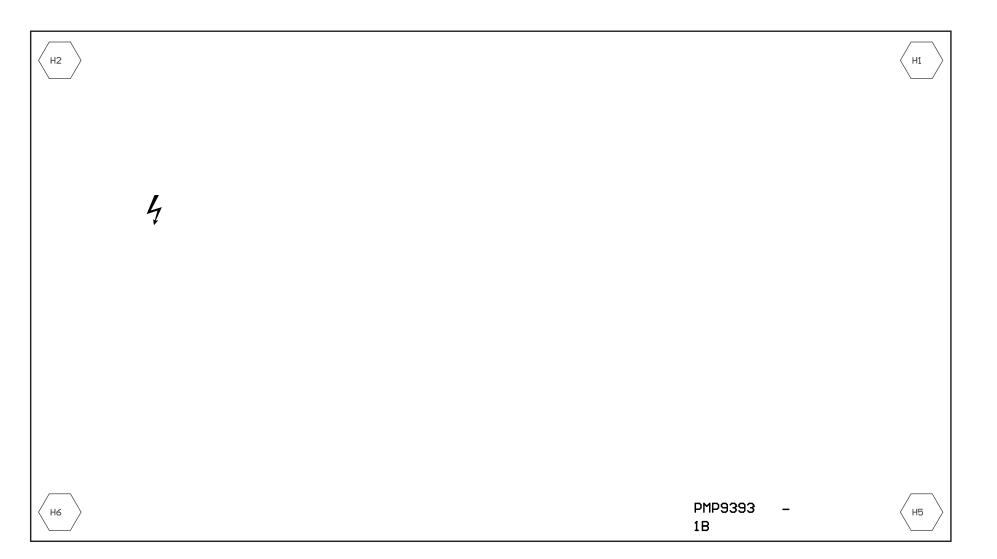
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9393	REV: 1B	SVN REV	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 3/24/2	2015 3:56:53	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9393	REV: 1B	SVN REV: Not In VersionControl		
	Bottom Overlay <- SNONDI				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/24/2	2015 3:56:54	PM	TEXAS INSTRUMENTS	

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